

ightarrow ightarrow ightarrow Inductors (Coils) ightarrow Detailed Information

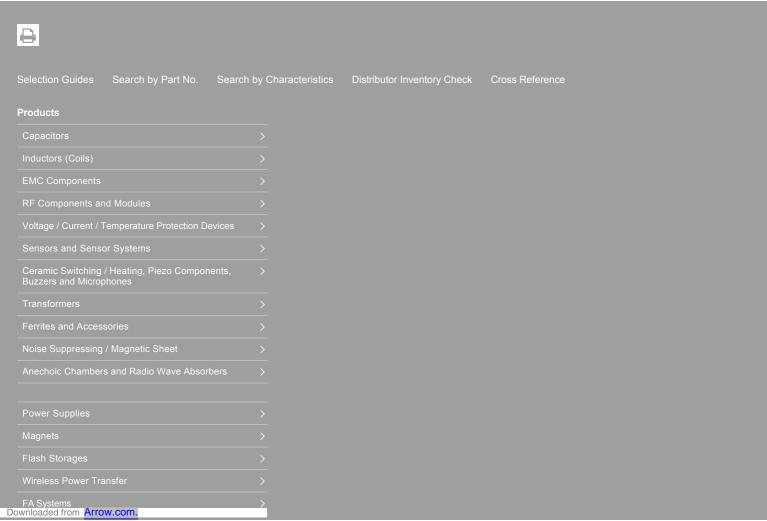
Inductors (Coils)

Product Top Pag	ge Sea	arch by Part	No.	Search by Ch	aracteristics	Cross Reference	e Catalog	Tech Notes	▼ more
MHQ04	02P	18NH	ТО	00					RoHS SVHC-Free Halogen Free Lea Free
Applications	Commercial Grade							PDF file of this page	
Feature	Multilayer Multilayer Non-Mag Core Non-Magnetic Core (Dielectric Ceramic) Super High Q Super High Q					c)		¢ , * Osugan han	Contact
Series Type	De MHQ-P								Documents
Status	Production (Not Recommended for Recommended Alternate Part No. : <u>Mt</u> hangeability is not guaranteed.)) a	Images are for refer and show exemplar		Catalog Catalog Control Certificate SVHC/REACH Certificate
Brand	TDK	ГДК							 Product Lineup [Selection Guide] Inductors for high frequency applications Update
Size									Sample Kits
Length(L)					0.44mm ±0.0)2mm			Technical Support Tools
Width(W)					0.24mm ±0.0				S-parameter
Thickness Hei	aht				0.24mm ±0.0				SPICE Netlist (Simple)
Recommended	-	ttern (A)			0.15mm to 0				SPICE Netlist (Precision)
Recommended					0.20mm Nor				Equivalent Circuit Model
Recommended Land Pattern (C)				0.18mm to 0.20mm					
		. ,							
Electrical Char	acterist	ics							
Inductance				18nH ±3% at 500MHz					
Rated Current				140mA					
DC Resistance	DC Resistance [Typ.]				1.45Ω				
DC Resistance [Max.]				2.5Ω					
Self Resonant F	requenc	y [Min.]			2GHz				
Self Resonant F	requenc	y [Typ.]			3GHz				
Q [Min.]				10 at 500MH	Z				
Q [Typ.]					13 at 500MH	z			
Other									
Operating Temp. Range (Including Self-Temp. Rise)			mp. Rise)	-55 to 125°C					
Soldering Method				Reflow					
AEC-Q200					No				
Packing				Punched (Paper)Taping [180mm Reel]					
Package Quantity					20000pcs				
Weight					0.00011g				

Characteristic Graph (This is reference data, and does not guarantee the products characteristics.)

Impedance

MHQ0402P18NHT000	MHQ0402P18NHT000
Change settings	Change settings
Inductance	Q
MHQ0402P18NHT000	MHQ0402P18NHT000
Change settings	Change settings



Transparent Conductive Film	>	
Micro Modules (Substrates with Built-in ICs, Products Utilizing with SESUB)		
Solar Cells		
Biosensor		
Application Specific IC (ASIC) Development and Supply		
Application Guides		
Technical Support		
Tech Library		
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